

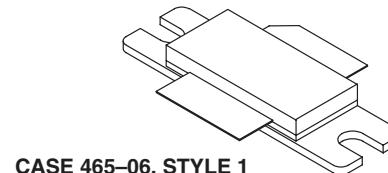
The RF MOSFET Line RF Power Field Effect Transistors N-Channel Enhancement-Mode Lateral MOSFETs

Designed for PCN and PCS base station applications with frequencies from 1.8 to 2.0 GHz. Suitable for FM, TDMA, CDMA and multicarrier amplifier applications. To be used in Class AB for PCN-PCS/cellular radio and WLL applications. Specified for GSM1805 – 1880 MHz.

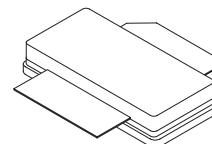
- Typical GSM Performance, Full Frequency Band (1805 – 1880 MHz)
 - Power Gain — 13 dB (Typ) @ 60 Watts
 - Efficiency — 45% (Typ) @ 60 Watts
- Internally Matched, Controlled Q, for Ease of Use
- High Gain, High Efficiency and High Linearity
- Integrated ESD Protection
- Designed for Maximum Gain and Insertion Phase Flatness
- Capable of Handling 10:1 VSWR, @ 26 Vdc, 60 Watts CW Output Power
- Excellent Thermal Stability
- Available in Tape and Reel. R3 Suffix = 250 Units per 56 mm, 13 Inch Reel.
- Available with Low Gold Plating Thickness on Leads. L Suffix Indicates 40 μ " Nominal.

**MRF18060A
MRF18060AR3
MRF18060ALSR3
MRF18060ASR3**

1.80 – 1.88 GHz, 60 W, 26 V
LATERAL N-CHANNEL
RF POWER MOSFETs



CASE 465-06, STYLE 1
NI-780
MRF18060A



CASE 465A-06, STYLE 1
NI-780S
MRF18060ALSR3, MRF18060ASR3

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain-Source Voltage	V _{DSS}	65	Vdc
Gate-Source Voltage	V _{GS}	-0.5, +15	Vdc
Total Device Dissipation @ T _C ≥ 25°C Derate above 25°C	P _D	180 1.03	Watts W/°C
Storage Temperature Range	T _{stg}	-65 to +150	°C
Operating Junction Temperature	T _J	200	°C

ESD PROTECTION CHARACTERISTICS

Test Conditions	Class
Human Body Model	2 (Minimum)
Machine Model	M3 (Minimum)

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Case	R _{θJC}	0.97	°C/W

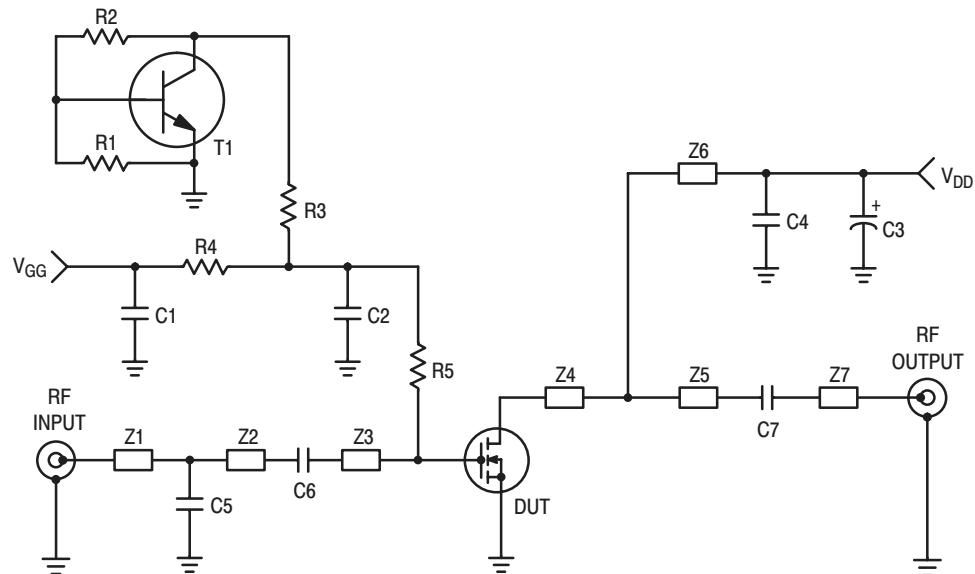
NOTE – **CAUTION** – MOS devices are susceptible to damage from electrostatic charge. Reasonable precautions in handling and packaging MOS devices should be observed.

ELECTRICAL CHARACTERISTICS ($T_C = 25^\circ\text{C}$ unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Drain–Source Breakdown Voltage ($V_{GS} = 0 \text{ Vdc}$, $I_D = 10 \mu\text{A}\text{dc}$)	$V_{(BR)DSS}$	65	—	—	Vdc
Zero Gate Voltage Drain Current ($V_{DS} = 26 \text{ Vdc}$, $V_{GS} = 0 \text{ Vdc}$)	I_{DSS}	—	—	6	$\mu\text{A}\text{dc}$
Gate–Source Leakage Current ($V_{GS} = 5 \text{ Vdc}$, $V_{DS} = 0 \text{ Vdc}$)	I_{GSS}	—	—	1	$\mu\text{A}\text{dc}$
ON CHARACTERISTICS					
Gate Threshold Voltage ($V_{DS} = 10 \text{ Vdc}$, $I_D = 300 \mu\text{A}\text{dc}$)	$V_{GS(\text{th})}$	2	—	4	Vdc
Gate Quiescent Voltage ($V_{DS} = 26 \text{ Vdc}$, $I_D = 500 \text{ mA}\text{dc}$)	$V_{GS(Q)}$	2.5	3.9	4.5	Vdc
Drain–Source On–Voltage ($V_{GS} = 10 \text{ Vdc}$, $I_D = 2 \text{ Adc}$)	$V_{DS(\text{on})}$	—	0.27	—	Vdc
Forward Transconductance ($V_{DS} = 10 \text{ Vdc}$, $I_D = 2 \text{ Adc}$)	g_{fs}	—	4.7	—	S
DYNAMIC CHARACTERISTICS					
Input Capacitance (Including Input Matching Capacitor in Package) (1) ($V_{DS} = 26 \text{ Vdc} \pm 30 \text{ mV(rms)}\text{ac}$ @ 1 MHz, $V_{GS} = 0 \text{ Vdc}$)	C_{iss}	—	160	—	pF
Output Capacitance (1) ($V_{DS} = 26 \text{ Vdc} \pm 30 \text{ mV(rms)}\text{ac}$ @ 1 MHz, $V_{GS} = 0 \text{ Vdc}$)	C_{oss}	—	740	—	pF
Reverse Transfer Capacitance ($V_{DS} = 26 \text{ Vdc} \pm 30 \text{ mV(rms)}\text{ac}$ @ 1 MHz, $V_{GS} = 0 \text{ Vdc}$)	C_{rss}	—	2.7	—	pF
FUNCTIONAL TESTS (In Motorola Test Fixture, 50 ohm system)					
Common–Source Amplifier Power Gain @ 60 W (2) ($V_{DD} = 26 \text{ Vdc}$, $I_{DQ} = 500 \text{ mA}$, $f = 1805 - 1880 \text{ MHz}$)	G_{ps}	11.5	13	—	dB
Drain Efficiency @ 60 W (2) ($V_{DD} = 26 \text{ Vdc}$, $I_{DQ} = 500 \text{ mA}$, $f = 1805 - 1880 \text{ MHz}$)	η	43	45	—	%
Input Return Loss (2) ($V_{DD} = 26 \text{ Vdc}$, $P_{out} = 60 \text{ W CW}$, $I_{DQ} = 500 \text{ mA}$, $f = 1805 - 1880 \text{ MHz}$)	IRL	—	—	-10	dB
Output Mismatch Stress ($V_{DD} = 26 \text{ Vdc}$, $P_{out} = 60 \text{ W CW}$, $I_{DQ} = 500 \text{ mA}$ VSWR = 10:1, All Phase Angles at Frequency of Tests)	Ψ	No Degradation In Output Power Before and After Test			

(1) Part is internally matched both on input and output.

(2) To meet application requirements, Motorola test fixtures have been designed to cover the full GSM1800 band, ensuring batch-to-batch consistency.



C1 100 nF Chip Capacitor (1203)

C2, C4, C7 10 pF Chip Capacitors

C3 10 μ F, 35 V Electrolytic Tantalum Capacitor

C5 1.2 pF Chip Capacitor

C6 1.0 pF Chip Capacitor

R1, R3 2.2 k Ω Chip Resistors (0805)

R2, R4 2.7 k Ω Chip Resistors (0805)

R5 1.1 k Ω Chip Resistor (0805)

T1 BC847 Transistor SOT-23

Z1 0.47" x 0.09" Microstrip

Z2 1.16" x 0.09" Microstrip

Z3 0.57" x 0.95" Microstrip

Z4 0.59" x 1.18" Microstrip

Z5 1.26" x 0.15" Microstrip

Z6 1.15" x 0.09" Microstrip

Z7 0.37" x 0.09" Microstrip

Figure 1. 1805 – 1880 MHz Test Fixture Schematic

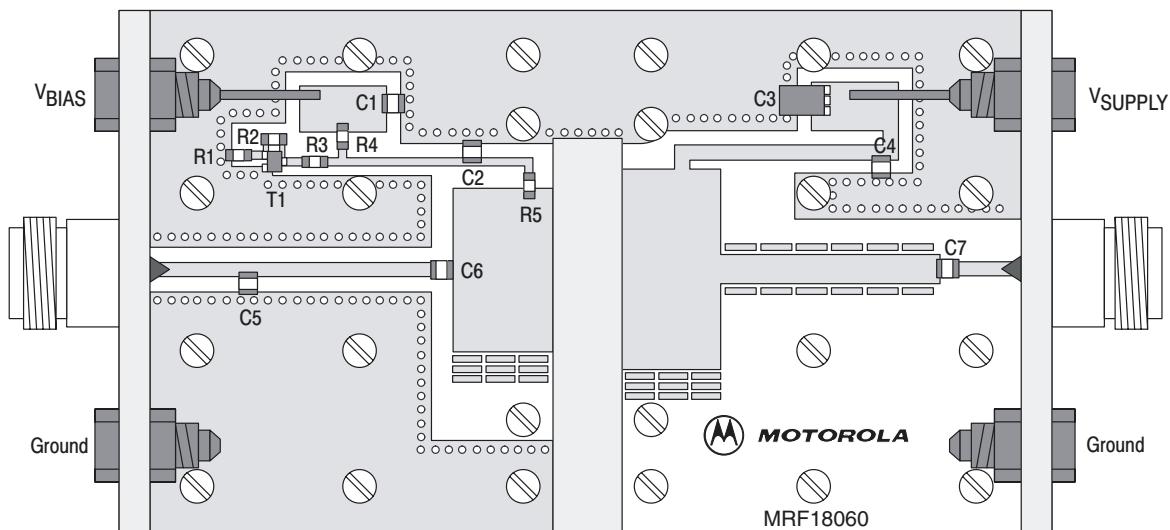
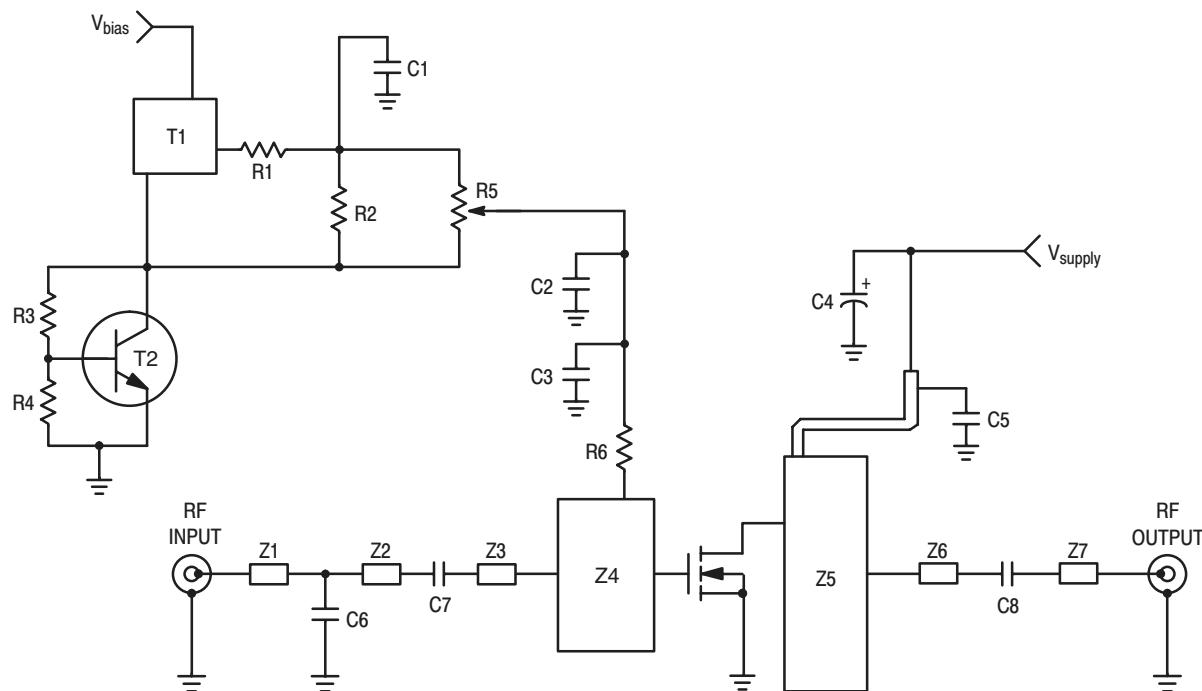


Figure 2. 1805 – 1880 MHz Test Fixture Component Layout



C1 1 μF Chip Capacitor (0805)
 C2 100 nF Chip Capacitor (0805)
 C3, C5, C8 10 pF Chip Capacitors, ACCU-P (0805)
 C4 10 μF , 35 V Tantalum Electrolytic Capacitor
 C6 1.8 pF Chip Capacitor, ACCU-P (0805)
 C7 1 pF Chip Capacitor, ACCU-P (0805)
 R1 10 Ω Chip Resistor (0805)
 R2, R6 1 k Ω Chip Resistors (0805)
 R3 1.2 k Ω Chip Resistor (0805)
 R4 2.2 k Ω Chip Resistor (0805)
 R5 5 k Ω , SMD Potentiometer

T1 LP2951 Micro-8 Voltage Regulator
 T2 BC847 SOT-23 NPN Transistor
 Z1 0.159" x 0.055" Microstrip
 Z2 0.982" x 0.055" Microstrip
 Z3 0.087" x 0.055" Microstrip
 Z4 0.512" x 0.787" Microstrip
 Z5 0.433" x 1.220" Microstrip
 Z6 1.039" x 0.118" Microstrip
 Z7 0.268" x 0.055" Microstrip
 Substrate = 0.5 mm Teflon® Glass, $\epsilon_r = 2.55$

Figure 3. 1800 – 2000 MHz Demo Board Schematic

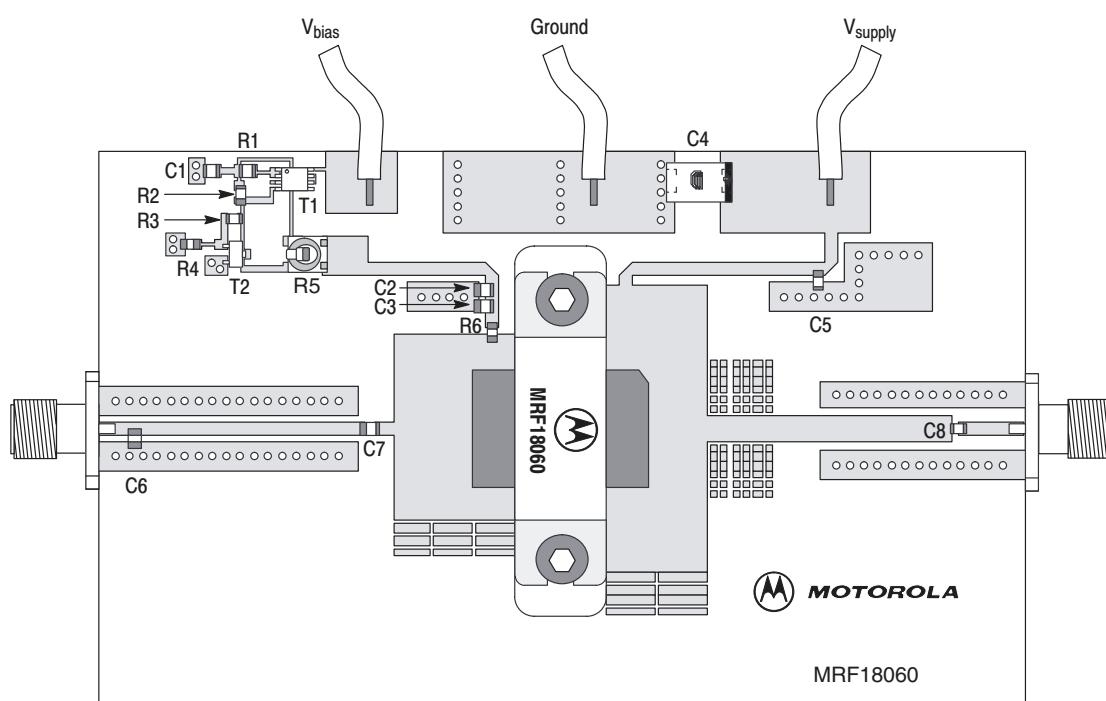


Figure 4. 1800 – 2000 MHz Demo Board Component Layout

TYPICAL CHARACTERISTICS (DATA TAKEN USING WIDEBAND DEMONSTRATION BOARD)

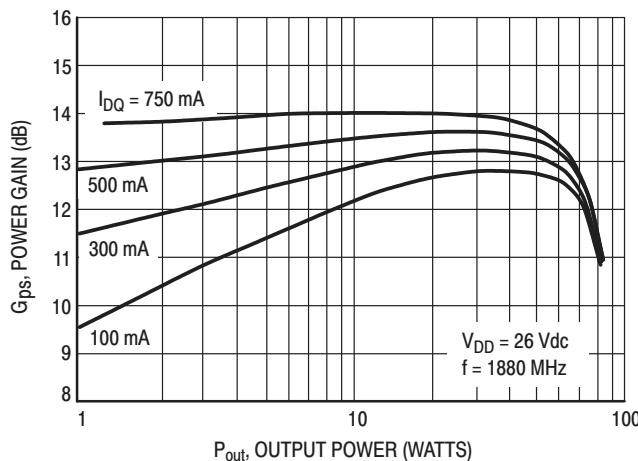


Figure 5. Power Gain versus Output Power

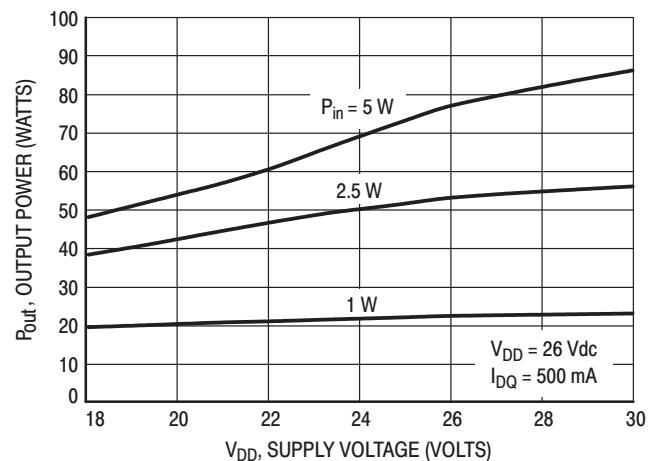


Figure 6. Output Power versus Supply Voltage

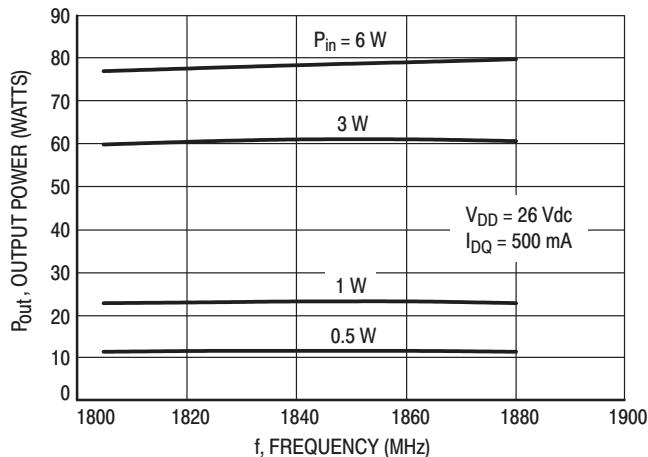


Figure 7. Output Power versus Frequency

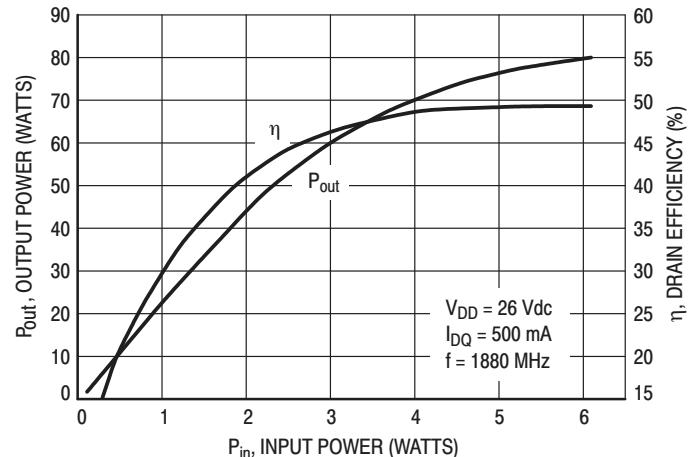


Figure 8. Output Power and Efficiency versus Input Power

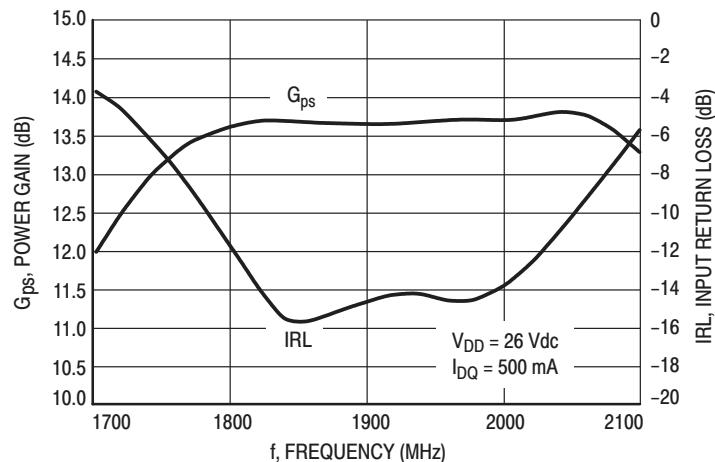
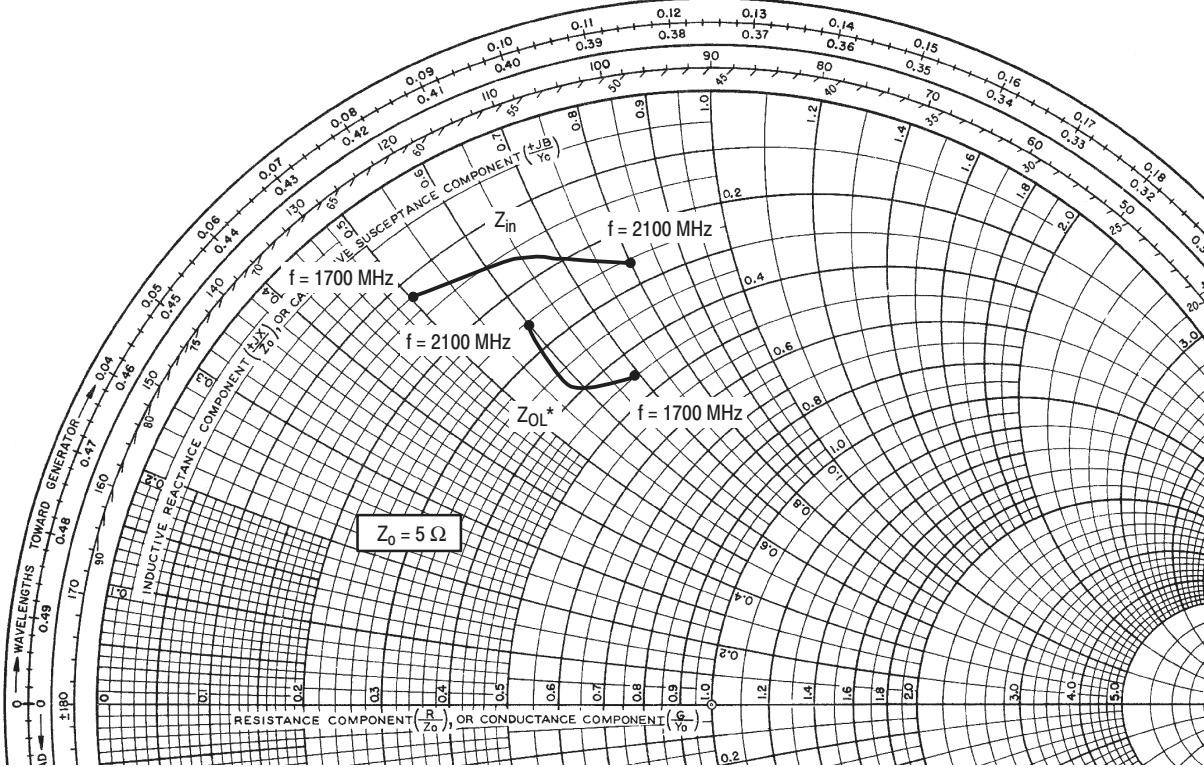


Figure 9. Wideband Gain and IRL (at Small Signal)



$V_{DD} = 26 \text{ V}, I_{DQ} = 500 \text{ mA}, P_{out} = 60 \text{ W CW}$

f MHz	Z_{in} Ω	Z_{OL^*} Ω
1700	$0.60 + j2.53$	$2.27 + j3.44$
1800	$0.80 + j3.20$	$2.05 + j3.05$
1900	$0.92 + j3.42$	$1.90 + j2.90$
2000	$1.07 + j3.59$	$1.64 + j2.88$
2100	$1.31 + j4.00$	$1.29 + j2.99$

Z_{in} = Complex conjugate of the source impedance.

Z_{OL^*} = Complex conjugate of the optimum load at a given voltage, P1dB, gain, efficiency, bias current and frequency.

Note: Z_{OL^*} was chosen based on tradeoffs between gain, output power, and drain efficiency.

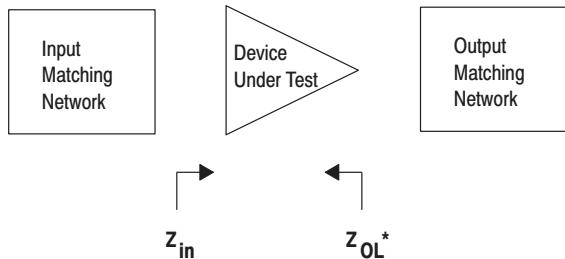
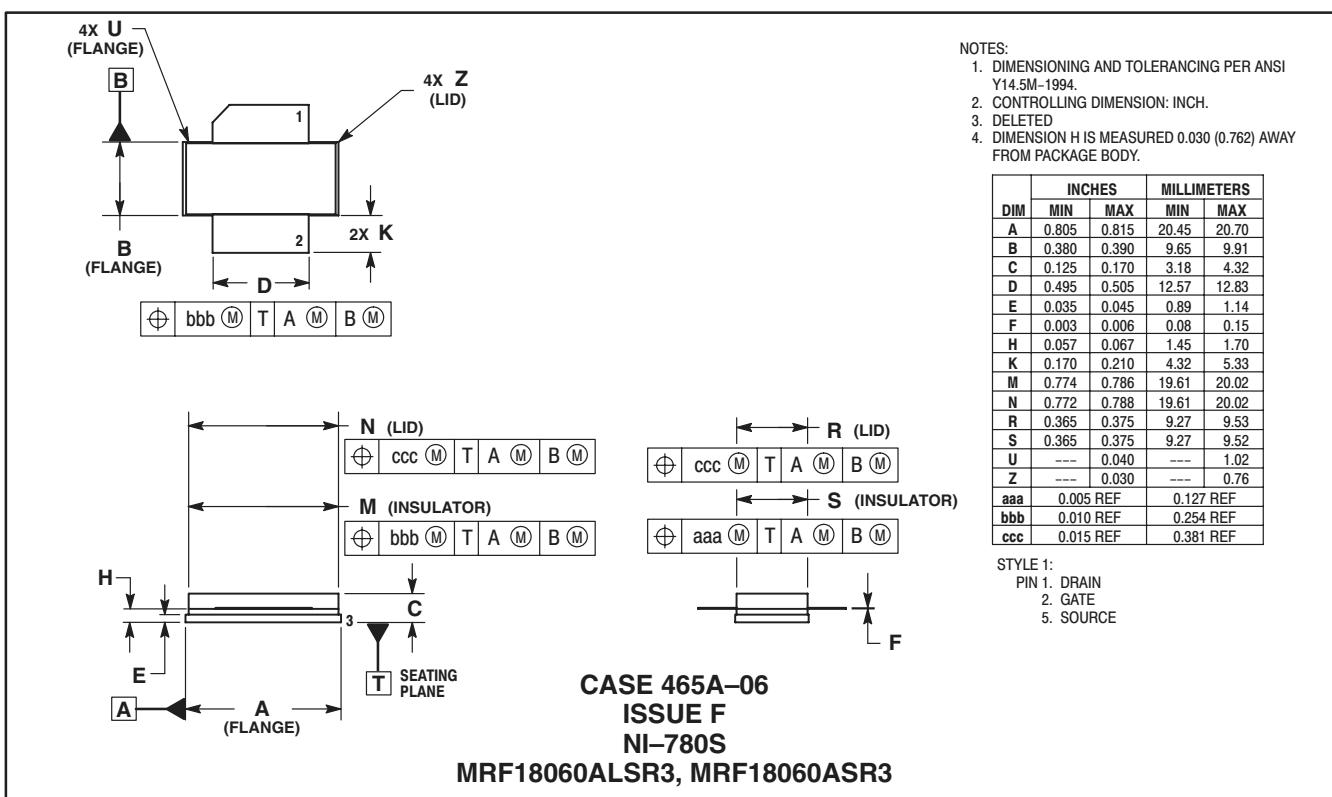
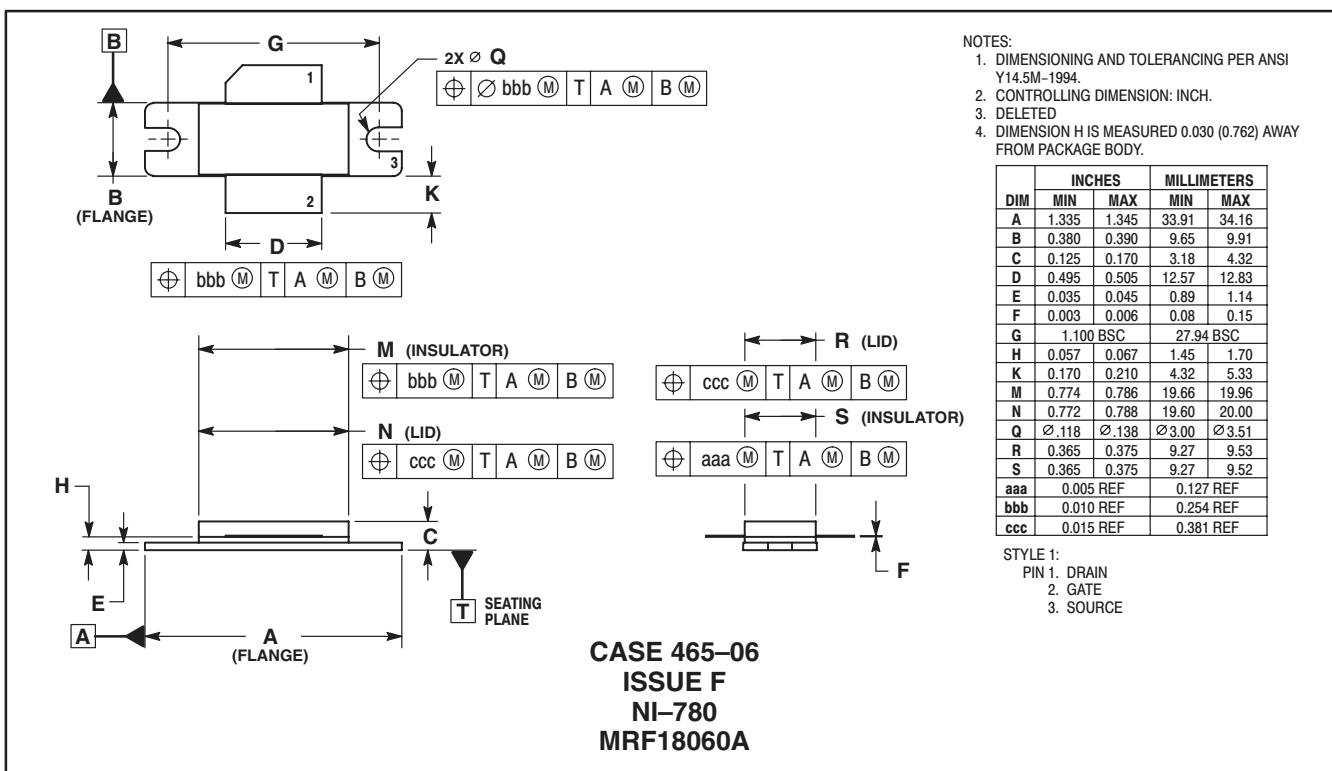


Figure 10. Series Equivalent Input and Output Impedance

PACKAGE DIMENSIONS



Motorola reserves the right to make changes without further notice to any products herein. Motorola makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does Motorola assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation consequential or incidental damages. "Typical" parameters which may be provided in Motorola data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. Motorola does not convey any license under its patent rights nor the rights of others. Motorola products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the Motorola product could create a situation where personal injury or death may occur. Should Buyer purchase or use Motorola products for any such unintended or unauthorized application, Buyer shall indemnify and hold Motorola and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that Motorola was negligent regarding the design or manufacture of the part. Motorola, Inc. Motorola, Inc. is an Equal Opportunity/Affirmative Action Employer. MOTOROLA and the  logo are registered in the US Patent & Trademark Office. All other product or service names are the property of their respective owners.

© Motorola, Inc. 2002.

How to reach us:

USA/EUROPE/Locations Not Listed: Motorola Literature Distribution; P.O. Box 5405, Denver, Colorado 80217. 1-303-675-2140 or 1-800-441-2447

JAPAN: Motorola Japan Ltd.; SPS, Technical Information Center, 3-20-1, Minami-Azabu. Minato-ku, Tokyo 106-8573 Japan. 81-3-3440-3569

ASIA/PACIFIC: Motorola Semiconductors H.K. Ltd.; Silicon Harbour Centre, 2 Dai King Street, Tai Po Industrial Estate, Tai Po, N.T., Hong Kong. 852-26668334

Technical Information Center: 1-800-521-6274

HOME PAGE: <http://www.motorola.com/semiconductors/>

